

# Product Specification PE4150

### **Product Description**

The PE4150 is an ultra-high linearity Quad MOSFET mixer with an integrated LO amplifier. The LO amplifier allows for LO drive levels of less than 0dBm to produce IIP3 values similar to a Quad MOSFET Array driven with a 15 dBm LO drive. The PE4150 operates with differential signals at the RF and IF ports and the integrated LO buffer amplifier drives the mixer core. It can be used as an upconverter or a downconverter.

The PE4150 is manufactured on Peregrine's UltraCMOS<sup>™</sup> process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.

### Figure 1. Functional Diagram

# UltraCMOS<sup>™</sup> Low Frequency Passive Mixer with Integrated LO Amplifier

### Features

- Ultra-high linearity Quad MOSFET array with integrated LO amplifier
- Ideal for mobile radio and Up/down conversion applications
- Low conversion loss
- High LO Isolation
- Packaged in small 4x4x0.85mm 20-lead QFN



4x4x.085 mm 20-Lead QFN





### Table 1. AC and DC Electrical Specifications (V<sub>DD</sub> = 2.9 to 3.1 V, Temperature = -40 to +85 °C unless specified otherwise)

Parameters	Min	Тур	Max	Units
Current Drain (a function of frequency)		8	12	mA
Off state leakage current			20	μΑ
RF Input Frequency VHF Band UHF1 Band UHF2 Band 700 MHz 800 MHz 900 MHz	136 380 450 764 851 935		174 470 520 776 870 941	MHz MHz MHz MHz MHz MHz
LO Frequency VHF Band UHF1 Band UHF2 Band 700 MHz 800 MHz 900 MHz	245.65 270.35 340.35 873.65 741.35 825.35		283.65 360.35 410.35 885.65 760.35 831.35	MHz MHz MHz MHz MHz MHz
IF Output Frequency	44.85		109.65	MHz
LO Input Power	-10		-6	dBm
RF Input Power			2	dBm
Conversion Loss VHF, UHF1, UHF2 700, 800, and 900 MHz	$\langle$	6.5 7.5	8 8.7	dB dB
3 <sup>rd</sup> Order Input Intercept (IIP3) <sup>2</sup>	20	25		dBm
2 <sup>nd</sup> Order Input Intercept (IIP2) VHF, UHF1, UHF2 700, 800 and 900 MHz	41 35	60 50		dBm dBm
RF to IF Isolation <sup>1</sup> VHF, UHF1, UHF2 700, 800 and 900 MHz	35 25	50 45		dB dB
LO to IF Isolation	20	30		dB
LO to RF Isolation	25	30		dB

Notes: 1. The RF to IF Isolation is measured with an input frequency equal with IF.

2. IIP3 is measured with two tones at 0 dBm, 100kHz spacing



### Figure 3. Pin Configuration (Top View)



### Table 2. Pin Descriptions

Pin #	Symbol	Description	
1	GND	Ground	
2	INB	Negative LO Input	
3	INA	Positive LO Input	
4	N/C	No Connect	
5	N/C	No Connect	
6	ĒN	Enable Pin (active low)	
7	V <sub>DD</sub>	V <sub>DD</sub>	
8	IF_P	Positive IF port	
9	GND	Ground	
10	IF_M	Negative IF port	
11	GND	Ground	
12	RF_P	Positive RF Input	
13	RF_M	Negative LO Input	
14	GND	Ground	
15	MixBias	External Mixer Bias	
16	N/C	No Connect	
17	N/C	No Connect	
18	V <sub>DD</sub>	V <sub>DD</sub>	
19	V <sub>DD</sub>	V <sub>DD</sub>	
20	GND	Ground	
Pad	GND	Exposed Ground Paddle	

The RF and IF pins are differential signals connected directly to the passive mixer. The LO input can be differential or single-ended.

### Table 3. Operating Ranges

Symbol	Parameters/Conditions	Min	Тур	Max	Units
$V_{\text{DD}}$	V <sub>DD</sub> Power Supply Voltage	2.9	3.0	3.1	V
T <sub>OP</sub>	Operating temperature range	-40		85	°C

### **Moisture Sensitivity Level**

The Moisture Sensitivity Level rating for the PE4150 in the 4x4x0.85 mm 20-lead QFN package is MSL3.

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Supply Voltage		4.0	V
Maximum DC plus peak AC across drain-source		±3.3	v
Maximum DC current across drain-source		6	mA
Maximum AC current across drain-source		36	$mA_{p-p}$
Storage temperature range	-65	150	°C
Operating Junction Temperature		125	°C
ESD Voltage (HBM, MIL_STD 883 Method 3015.7)		1000	v
	Supply Voltage Maximum DC plus peak AC cross drain-source Maximum DC current across rain-source Maximum AC current across rain-source Storage temperature range Operating Junction Temperature SSD Voltage (HBM, MIL_STD 883 Method 0015.7)	Supply Voltage         Maximum DC plus peak AC         cross drain-source         Maximum DC current across         Irain-source         Maximum AC current across         Irain-source         Storage temperature range         Operating Junction         remperature         SSD Voltage (HBM, MIL_STD 883 Method 0015.7)	Supply Voltage4.0Maximum DC plus peak AC cross drain-source±3.3Maximum DC current across train-source6Maximum AC current across train-source36Storage temperature range-65Operating Junction remperature125SSD Voltage (HBM, MIL_STD 883 Method 0015.7)1000

#### Table 4. Absolute Maximum Ratings

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

### **Electrostatic Discharge (ESD) Precautions**

When handling this UltraCMOS<sup>™</sup> device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

### Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS<sup>™</sup> devices are immune to latch-up.

### **Device Description**

The PE4150 passive broadband Quad MOSFET array is designed for use in up-conversion and down-conversion applications for high performance systems such as mobile radios, cellular infrastructure equipment, and STB/CATV systems.

The PE4150 is an ideal mixer core for a wide range of mixer products, including module level solutions that incorporate baluns or other single-ended matching structures enabling three-port operation.

The performance level of this passive mixer is made possible by the very high linearity afforded by Peregrine's UltraCMOS<sup>™</sup> process.

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### **Evaluation Kit**

The Mixer Evaluation Kit board was designed to ease customer evaluation of the PE4150 Quad MOSFET Mixer with integrated LO amplifier.

The RF and IF ports are connected through 500hm transmission lines and 1:4 transmission line transformers to J5 and J7, respectively. The LO ports are connected through 50  $\Omega$  transmission lines to J4 and J6, respectively, and can support either a single-ended or differential signal drive. With a single-ended input, no termination is needed on the un-used port.

The board is constructed of a two metal layer FR4 with a total thickness of 0.062". The bottom layer provides ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 0.037", trace gaps of 0.008", dielectric thickness of 0.059" and metal thickness of 0.0015".

J3 provides an optional external DC bias that can be applied to the LO input, if there is DC component to the applied RF input. To use this option, transformers T2 and T3 must be carefully chosen to allow the use of a non-zero commonmode level.

J9 can be used to enable or disable the part. The chip enable/EN is active low.

De-coupling capacitors are provided on the  $V_{DD}$  traces. These capacitors should be placed as close to the  $DV_{DD}$  pin as possible.

Figure 4. Evaluation Board Layout

Peregrine Specification 101-0201-00A





### Figure 5. Evaluation Board Schematic

Peregrine Specification 102-0396



2. CAUTION:

CONTAINS PARTS AND ASSEMBLIES SUSCEPTIBLE TO DAMAGE BY ELECTROSTATIC DISCHARGE (ESD)

- 3. LO INPUT CAN BE DIFFERENTIAL OR SINGLE ENDED (INA/INB)
- 4. WITH SINGLE ENDED LO INPUT, NO TERMINATION IS NEEDED ON UNUSED PORT.
- 5. PINS 16 AND 17 ARE INTERNALLY DISCONNECTED.



### **Typical Performance Plots**



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### **Typical Performance Plots**

### Figure 10. Linearity vs V<sub>DD</sub>



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### Figure 14. Package Drawing

4x4x0.85 mm 20-lead QFN





### Figure 15. Tape and Reel Drawing



### Table 5. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
EK-4150-01	PE4150-EK	PE4150 – 20QFN 4x4mm-EK	Evaluation Kit	1 / Box
PE4150MLAB	4150	PE4150 G - 20QFN 4x4mm	Green 20-lead 4x4mm QFN	75 units
PE4150MLAB-Z	4150	PE4150 G -20QFN 4x4mm-3000C	Green 20-lead 4x4mm QFN	3000 units / T&R

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# **Data Sheet Identification**

### Advance Information

The product is in a formative or design stage. The data sheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

### Preliminary Specification

The data sheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

### **Product Specification**

The data sheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a CNF (Customer Notification Form).

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